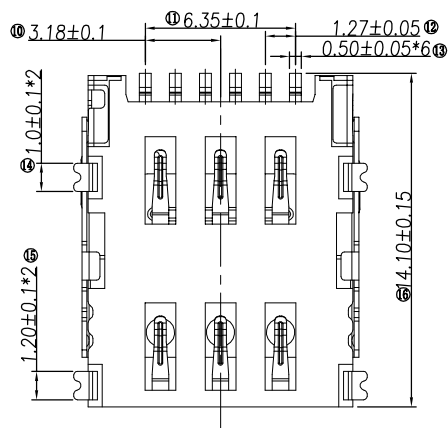
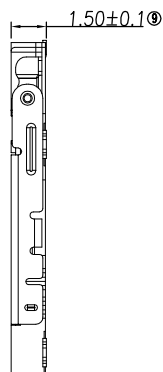
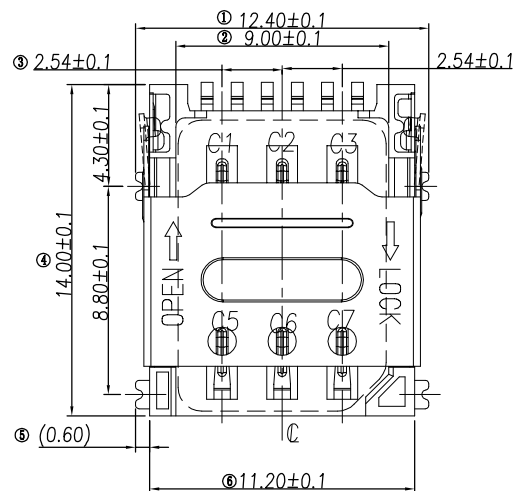
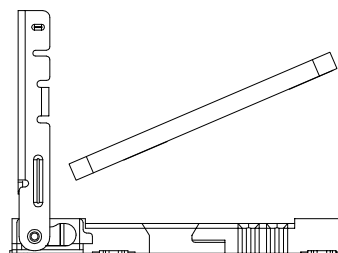
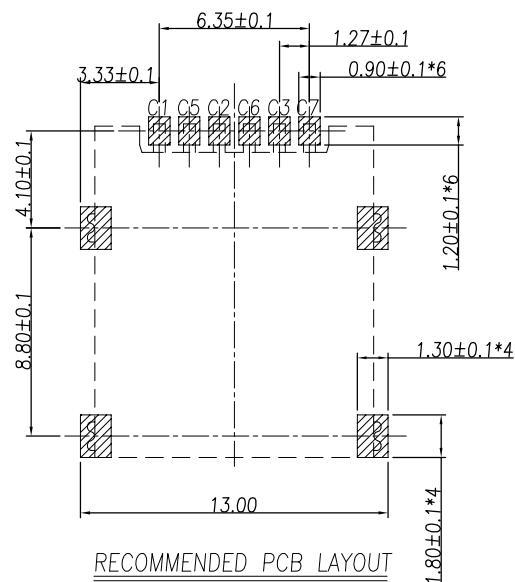
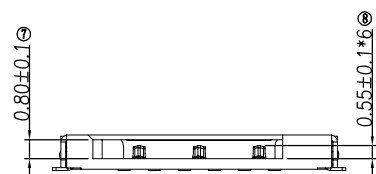
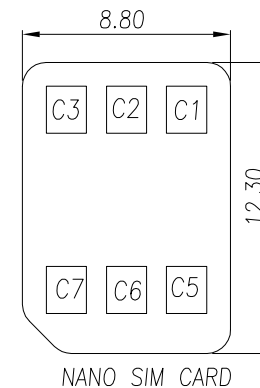


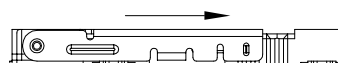
RoHS Compliant



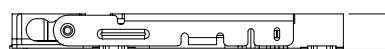
SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



STEP 1 INSERT Nano-SIM CARD



STEP 2 PUSH THE SHELL



STEP 3 FINISH

NOTES:

1. MATERIAL:

- 1.1. HOUSING: LCP,BLACK,UL94V-0;
1.2. CONTACT: C5191R-EH,T=0.12mm;
1.3. SHELL: SUS201,T=0.20mm;

2. **FINISH:**

- 2.1. CONTACT: GOLD 0.8u" MIN. PLATING ON CONTACT AREA,
GOLD FLASH PLATING ON SOLDER TAILS;
NICKEL 30u" MIN. UNDERPLATING OVER ALL.
- 2.2. SHELL: NICKEL 30u" MIN. PLATING OVER ALL.

3. PRODUCT SPECIFICATIONS:

- 3.1. VOLTAGE RATING: 10V;
3.2. CURRENT RATING: 0.5A;

- 3.3. CONTACT RESISTANCE: INITIALLY 100 MILL.OHM MAX.,
AFTER TEST 50 MILL.OHM MAX. CHANGE;

- 3.4. INSULATION RESISTANCE: INITIALLY 1000 MEG.OHM MIN.,
AFTER TEST 100MEG.OHM MIN.;

- 3.5. DIELECTRIC WITHSTANDING VOLTAGE: 250VAC MIN;
3.6. DURABILITY: 3000 CYCLES.

4. ENVIRONMENTAL:

- 4.1. OPERATION: $-30^{\circ}\text{C}\sim+85^{\circ}\text{C}$.

深圳市敏连达科技有限公司 Shenzhen Minlianda Technology Co.,Ltd.			品名(ITEM NO)	NANO SIM 6P掀盖1.5H	
			料号(PART NO)	MLD-NANO SIM XG6P-H1.5	
单位(UNIT): MM	未注公差 TOLERANCE UNSPECIFIED	版次(REV): A/0	页次(PAGE):1/1	设计 (DESIGN)	柯南
比例(SCALE) 1:1	X.X ± 0.38 X.XX ± 0.20 X.XXX ± 0.10 X" ± 5" X.X" ± 2"	模号 (MODEL NO)		审核 (CHECKED)	邱敏
		图号 (DWG NO)		MLD-2509031032	核准(APPROVED)